

here, exploits that quantum mechanical tunneling to appreciably cool a macroscale object, in this case a copper stage 2.5 cm on a side.

The cooling tunnel junctions, only a few hundred nanometers thick, reside on a silicon chip that appears gold on the right side of the interior green circuit board. A nanoscale membrane, small gold wires, and a copper "diving board" thermally link the junctions to the copper stage, which is suspended by four Kevlar threads. With 48 junctions in their prototype, the researchers cooled the stage from 290 mK to 256 mK, but they anticipate that their macrocooler geometry should be able to reach 100 mK—and even colder in multistage configurations. (P. J. Lowell et al., Appl. Phys. Lett. 102, 082601, 2013.)

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